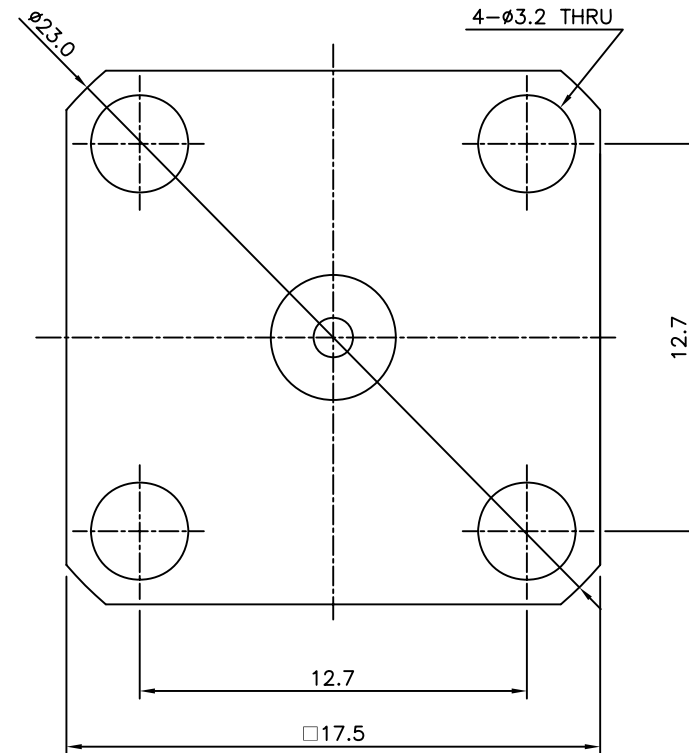
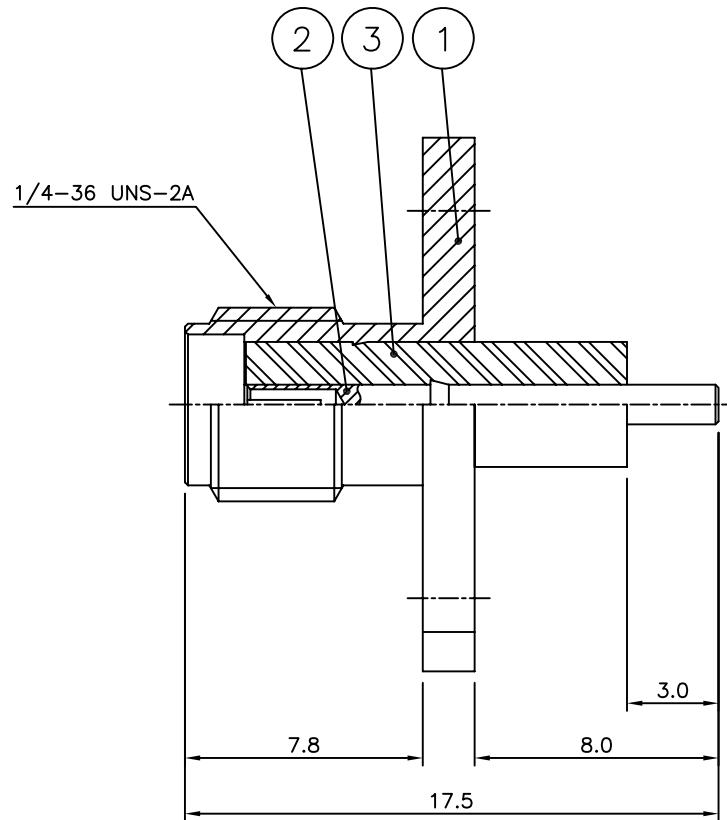


REVISION						
REV	DESCRIPTION			DRAWN	APPR	DATE
1R	Initial Registration			S.Y.EUN	I.C.KIM	2017.09.18.
1	절연체 공용화로 인한 코드 변경			S.Y.EUN	I.C.KIM	2020.12.24.



1	3	INSULATOR	1	TEFLON		DIN02077-N/1 DIN00088-N/1
	2	CONTACT	1	BeCu C17300	Gold Plate	DCT03884-5/1
	1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04355-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 12. 24.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM		
	±1°	CHECKED BY			
MATERIAL		DRAWN BY	S.Y.EUN		TITLE
-					SMA50 SOLDER END JS-4H
FINISH	-	SCALE	UNIT		DWG NO.
		4/1	mm		CN03733-7/1
					REVISION 1
					SHEET 1 of 1